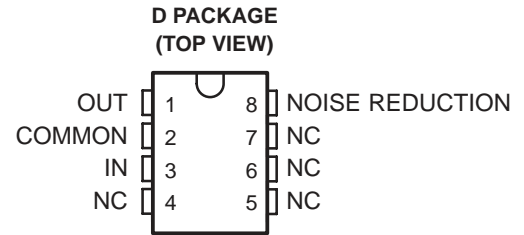


- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **One-Half V_I Virtual Ground for Analog Systems**
- **Micropower Operation . . . 170 μ A Typ, $V_I = 5$ V**
- **Wide V_I Range . . . 4 V to 40 V**
- **High Output-Current Capability**
 - Source . . . 20 mA Typ
 - Sink . . . 20 mA Typ

- **Excellent Output Regulation**
 - –102 μ V Typ at $I_O = 0$ mA to –10 mA
 - 49 μ V Typ at $I_O = 0$ mA to 10 mA
- **Low-Impedance Output . . . 0.0075 Ω Typ**
- **Noise Reduction Pin**

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



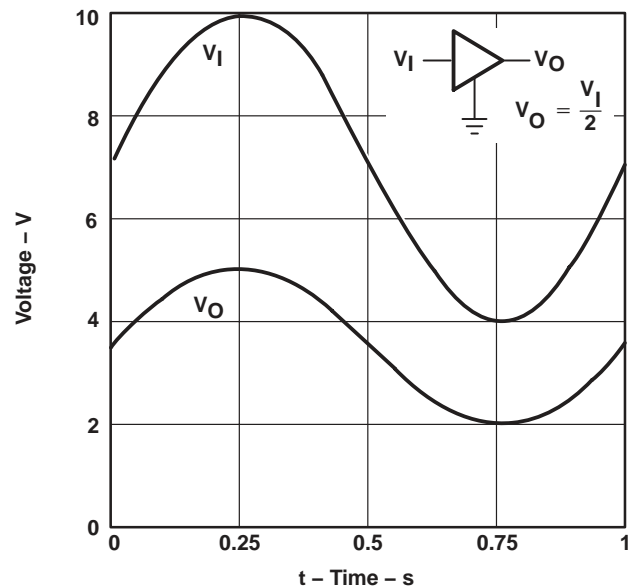
NC – No internal connection

description/ordering information

In signal-conditioning applications utilizing a single power source, a reference voltage equal to one-half the supply voltage is required for termination of all analog signal grounds. TI presents a precision virtual ground whose output voltage is always equal to one-half the input voltage—the TLE2426 rail splitter.

The unique combination of a high-performance, micropower operational amplifier and a precision-trimmed divider on a single silicon chip results in a precise V_O/V_I ratio of 0.5 while sinking and sourcing current. The TLE2426 provides a low-impedance output with 20 mA of sink and source capability, while drawing less than 280 μ A of supply current over the full input range of 4 V to 40 V. A designer need not pay the price in terms of board space for a conventional signal ground consisting of resistors, capacitors, operational amplifiers, and voltage references. For increased performance, the 8-pin package provides a noise-reduction pin. With the addition of an external capacitor (C_{NR}), peak-to-peak noise is reduced, while line ripple rejection is improved.

INPUT/OUTPUT TRANSFER CHARACTERISTICS



Initial output tolerance for a single 5-V or 12-V system is better than 1% over the full 40-V input range. Ripple rejection exceeds 12 bits of accuracy. Whether the application is for a data-acquisition front end, analog signal termination, or simply a precision voltage reference, the TLE2426 eliminates a major source of system error.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

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TLE2426-EP
RAIL SPLITTER
PRECISION VIRTUAL GROUND

SGLS345 – JUNE 2006

ORDERING INFORMATION

| T _A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------|---------------|-----------------------|------------------|
| -55°C to 125°C | SOIC (D) | Tape and reel | TLE2426MDREP | 2426EP |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| | |
|---|------------------------------|
| Continuous input voltage, V _I | 40 V |
| Continuous filter trap voltage | 40 V |
| Output current, I _O | ±80 mA |
| Duration of short-circuit current at (or below) 25°C (see Note 1) | Unlimited |
| Continuous total power dissipation | See Dissipation Rating Table |
| Operating free-air temperature range, T _A | -55°C to 125°C |
| Operating junction temperature, T _J (see Note 2) | 150°C |
| Storage temperature range, T _{stg} (see Note 2) | 150°C |
| Lead temperature 1,6 mm (1/16 in) from case for 10 s | 260°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.
2. Long-term high-temperature storage and/or usage at the absolute maximum ratings may result in a reduction of overall device life. See http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

DISSIPATION RATING TABLE

| PACKAGE | T _A ≤ 25°C POWER RATING | DERATING FACTOR ABOVE T _A = 25°C | T _A = 70°C POWER RATING | T _A = 85°C POWER RATING | T _A = 125°C POWER RATING |
|---------|---------------------------------------|--|---------------------------------------|---------------------------------------|--|
| D | 1102 mW | 10.3 mW/°C | 638.5 mW | 484 mW | 72.1 mW |

recommended operating conditions

| | MIN | MAX | UNIT |
|--|-----|-----|------|
| Input voltage, V _I | 4 | 40 | V |
| Operating free-air temperature, T _A | -55 | 125 | °C |



electrical characteristics at specified free-air temperature, $V_I = 5\text{ V}$, $I_O = 0$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | T_A † | MIN | TYP | MAX | UNIT |
|---|--|---------------------------------|------------|--------|------|-------|--------|
| Output voltage | $V_I = 4\text{ V}$ | | 25°C | 1.98 | 2 | 2.02 | V |
| | $V_I = 5\text{ V}$ | | | 2.48 | 2.5 | 2.52 | |
| | $V_I = 40\text{ V}$ | | | 19.8 | 20 | 20.2 | |
| | $V_I = 5\text{ V}$ | | Full range | 2.465 | | 2.535 | |
| Temperature coefficient of output voltage | | | Full range | 25 | | | ppm/°C |
| Supply current | No load | $V_I = 5\text{ V}$ | 25°C | 170 | 300 | | µA |
| | | $V_I = 4\text{ to }40\text{ V}$ | 25°C | 350 | | | |
| | | | Full range | 400 | | | |
| Output voltage regulation (sourcing current)‡ | $I_O = 0\text{ to }-10\text{ mA}$ | | 25°C | -0.102 | ±0.7 | | mV |
| | | | Full range | ±10 | | | |
| | $I_O = 0\text{ to }-20\text{ mA}$ | | 25°C | -0.121 | ±1.4 | | |
| Output voltage regulation (sinking current)‡ | $I_O = 0\text{ to }10\text{ mA}$ | | 25°C | 0.049 | ±0.5 | | mV |
| | $I_O = 0\text{ to }8\text{ mA}$ | | Full range | ±10 | | | |
| | $I_O = 0\text{ to }20\text{ mA}$ | | 25°C | 0.175 | ±1.4 | | |
| Output impedance‡ | | | 25°C | 7.5 | 22.5 | | mΩ |
| Noise-reduction impedance | | | 25°C | 110 | | | kΩ |
| Short-circuit current | Sinking current, $V_O = 5\text{ V}$ | | 25°C | 26 | | | mA |
| | Sourcing current, $V_O = 0$ | | | -47 | | | |
| Output noise voltage, rms | $f = 10\text{ Hz to }10\text{ kHz}$ | $C_{NR} = 0$ | 25°C | 120 | | | µV |
| | | $C_{NR} = 1\text{ µF}$ | | 30 | | | |
| Output voltage current step response | $V_O\text{ to }0.1\%, I_O = \pm 10\text{ mA}$ | $C_L = 0$ | 25°C | 290 | | | µs |
| | | $C_L = 100\text{ pF}$ | | 275 | | | |
| | $V_O\text{ to }0.01\%, I_O = \pm 10\text{ mA}$ | $C_L = 0$ | 25°C | 400 | | | |
| | | $C_L = 100\text{ pF}$ | | 390 | | | |
| Step response | $V_I = 0\text{ to }5\text{ V}, V_O\text{ to }0.1\%$ | | 25°C | 20 | | | µs |
| | $V_I = 0\text{ to }5\text{ V}, V_O\text{ to }0.01\%$ | | | 120 | | | |

† Full range is -55°C to 125°C.

‡ The listed values are not production tested.

TLE2426-EP
RAIL SPLITTER
PRECISION VIRTUAL GROUND

SGLS345 – JUNE 2006

electrical characteristics at specified free-air temperature, $V_I = 12\text{ V}$, $I_O = 0$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | T_A † | MIN | TYP | MAX | UNIT |
|---|---|---------------------------------|------------|-------|------|--------|------|
| Output voltage | $V_I = 4\text{ V}$ | | 25°C | 1.98 | 2 | 2.02 | V |
| | $V_I = 12\text{ V}$ | | | 5.95 | 6 | 6.05 | |
| | $V_I = 40\text{ V}$ | | | 19.8 | 20 | 20.2 | |
| | $V_I = 12\text{ V}$ | | Full range | 5.925 | | 6.075 | |
| Temperature coefficient of output voltage | | | Full range | 35 | | ppm/°C | |
| Supply current | No load | $V_I = 12\text{ V}$ | 25°C | 195 | 300 | µA | |
| | | $V_I = 4\text{ to }40\text{ V}$ | 25°C | 350 | | | |
| | | | Full range | 400 | | | |
| Output voltage regulation (sourcing current)‡ | $I_O = 0\text{ to }-10\text{ mA}$ | | 25°C | -1.48 | ±10 | mV | |
| | | | Full range | ±10 | | | |
| Output voltage regulation (sinking current)‡ | $I_O = 0\text{ to }-20\text{ mA}$ | | 25°C | -3.9 | ±10 | mV | |
| | $I_O = 0\text{ to }10\text{ mA}$ | | 25°C | 2.27 | ±10 | | |
| | $I_O = 0\text{ to }8\text{ mA}$ | | Full range | ±10 | | | |
| Output impedance‡ | $I_O = 0\text{ to }20\text{ mA}$ | | 25°C | 4.3 | ±10 | mΩ | |
| | | | 25°C | 7.5 | 22.5 | | |
| Noise-reduction impedance | | | 25°C | 110 | | kΩ | |
| Short-circuit current | Sinking current, $V_O = 12\text{ V}$ | | 25°C | 31 | | mA | |
| | Sourcing current, $V_O = 0$ | | | -70 | | | |
| Output noise voltage, rms | $f = 10\text{ Hz to }10\text{ kHz}$ | $C_{NR} = 0$ | 25°C | 120 | | µV | |
| | | $C_{NR} = 1\text{ µF}$ | | 30 | | | |
| Output voltage current step response | $V_O\text{ to }0.1\%, I_O = \pm 10\text{ mA}$ | $C_L = 0$ | 25°C | 290 | | µs | |
| | | $C_L = 100\text{ pF}$ | | 275 | | | |
| | $V_O\text{ to }0.01\%, I_O = \pm 10\text{ mA}$ | $C_L = 0$ | 25°C | 400 | | | |
| | | $C_L = 100\text{ pF}$ | | 390 | | | |
| Step response | $V_I = 0\text{ to }12\text{ V}, V_O\text{ to }0.1\%$ | | 25°C | 12 | | µs | |
| | $V_I = 0\text{ to }12\text{ V}, V_O\text{ to }0.01\%$ | | | 120 | | | |

† Full range is -55°C to 125°C.

‡ The listed values are not production tested.



TYPICAL CHARACTERISTICS

Table of Graphs

| | | FIGURE |
|--|-------------------------|---------------|
| Output voltage | Distribution | 1, 2 |
| Output voltage change | vs Free-air temperature | 3 |
| Output voltage error | vs Input voltage | 4 |
| Input bias current | vs Input voltage | 5 |
| | vs Free-air temperature | 6 |
| Output voltage regulation | vs Output current | 7 |
| Output impedance | vs Frequency | 8 |
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| Output voltage response to output current step | vs Time | 15 |
| Output voltage power-up response | vs Time | 16 |
| Output current | vs Load capacitance | 17 |

TYPICAL CHARACTERISTICS†

DISTRIBUTION OF OUTPUT VOLTAGE

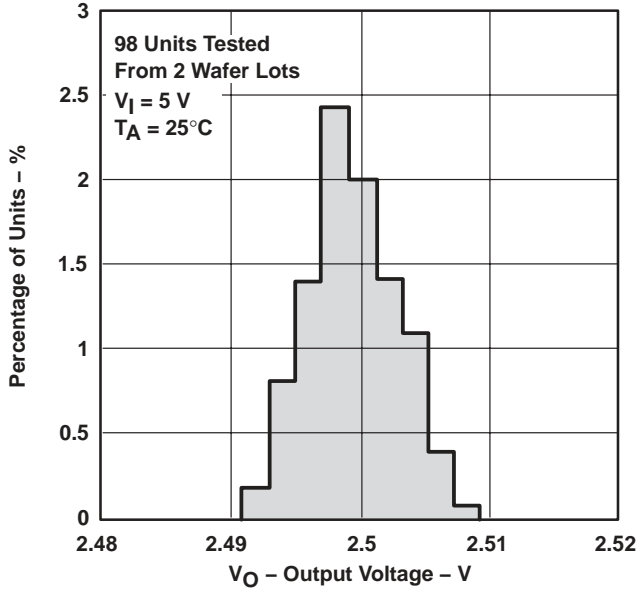


Figure 1

DISTRIBUTION OF OUTPUT VOLTAGE

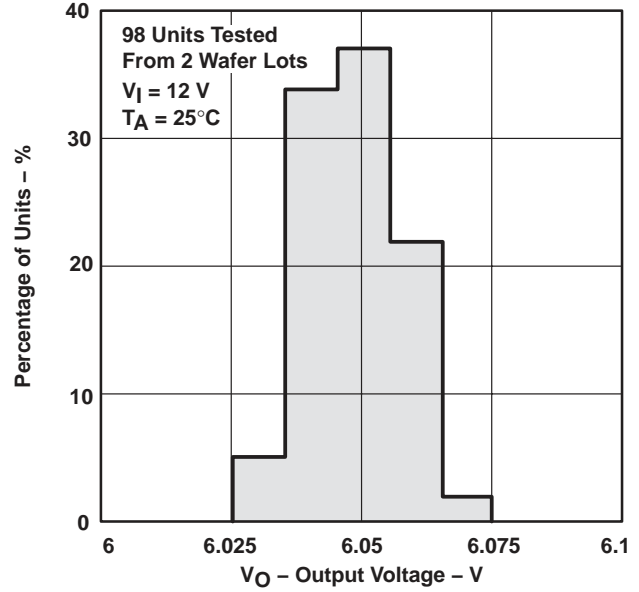


Figure 2

OUTPUT VOLTAGE CHANGE vs FREE-AIR TEMPERATURE

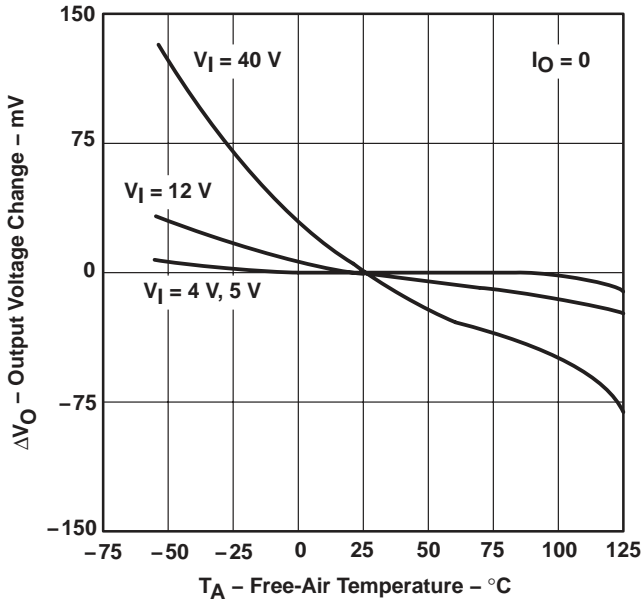


Figure 3

OUTPUT VOLTAGE ERROR vs INPUT VOLTAGE

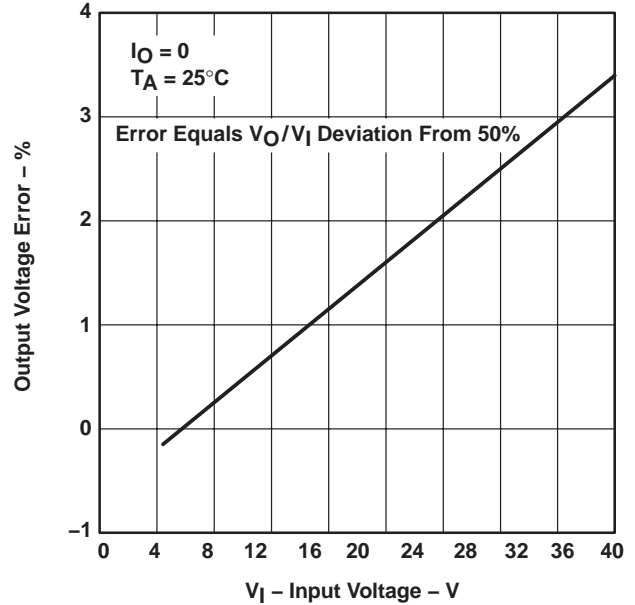


Figure 4

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

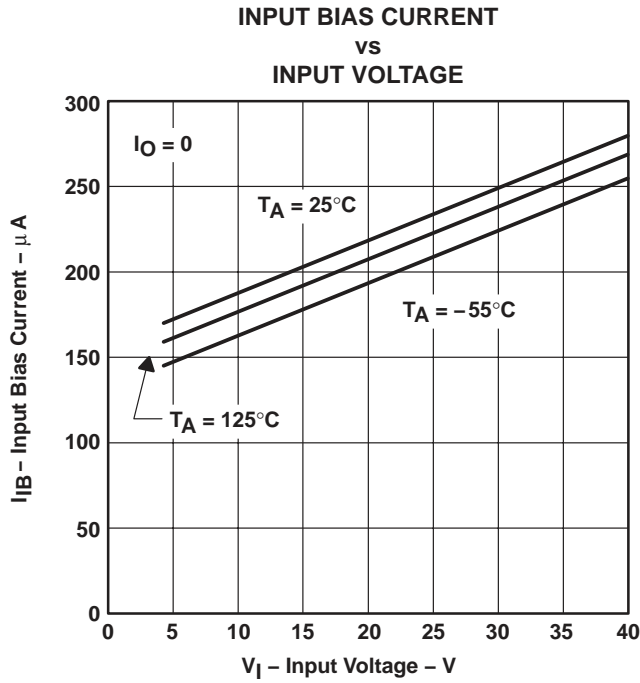


Figure 5

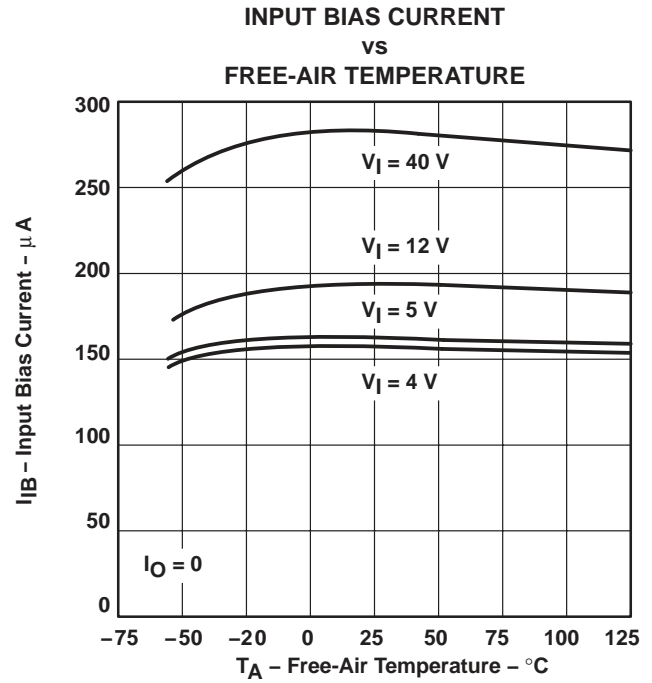


Figure 6

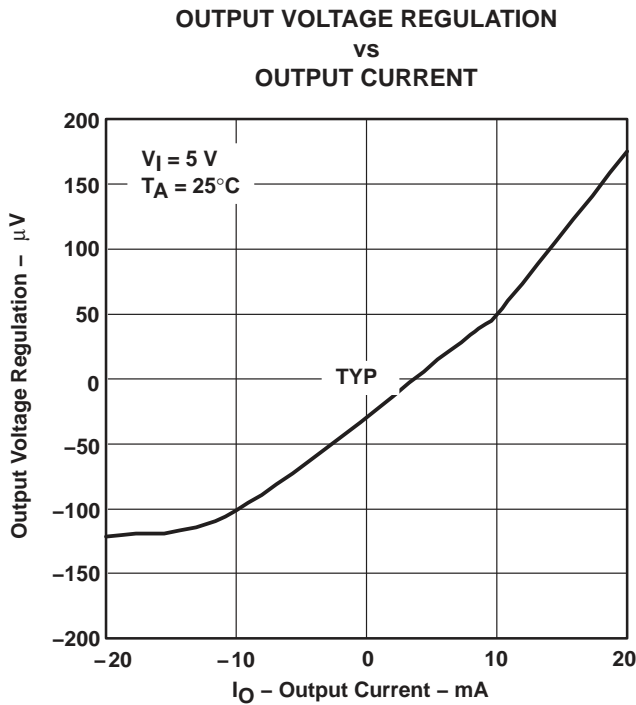


Figure 7

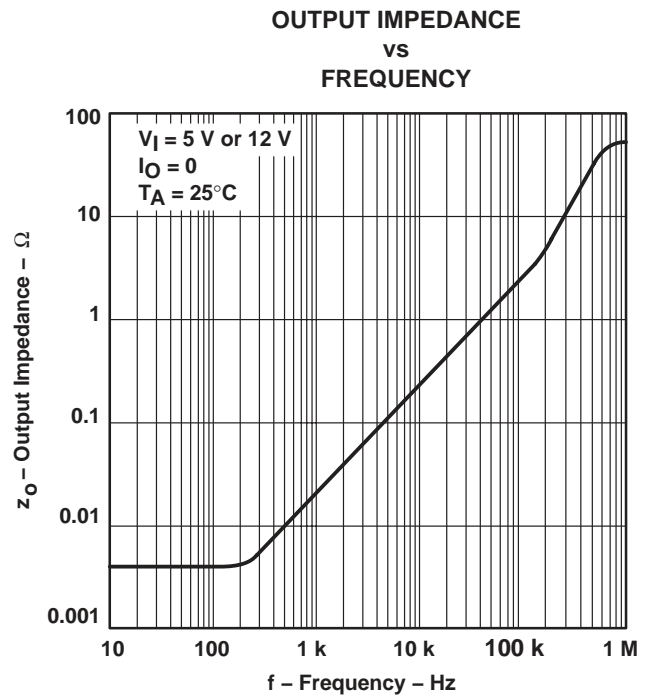


Figure 8

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

**SHORT-CIRCUIT OUTPUT CURRENT
 VS
 INPUT VOLTAGE**

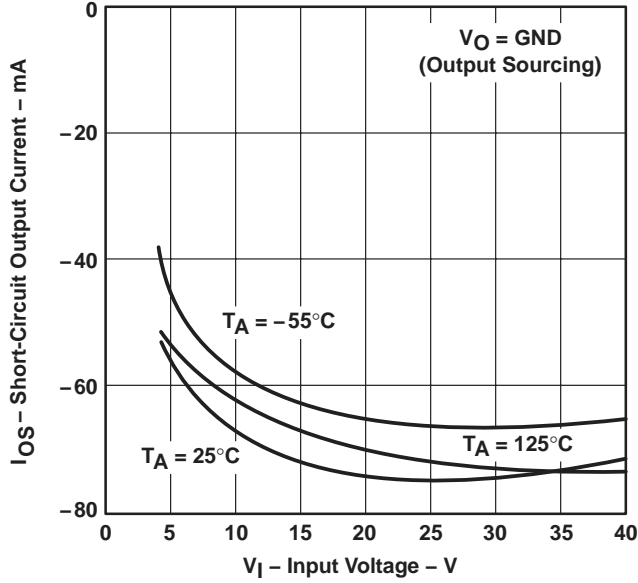


Figure 9

**SHORT-CIRCUIT OUTPUT CURRENT
 VS
 INPUT VOLTAGE**

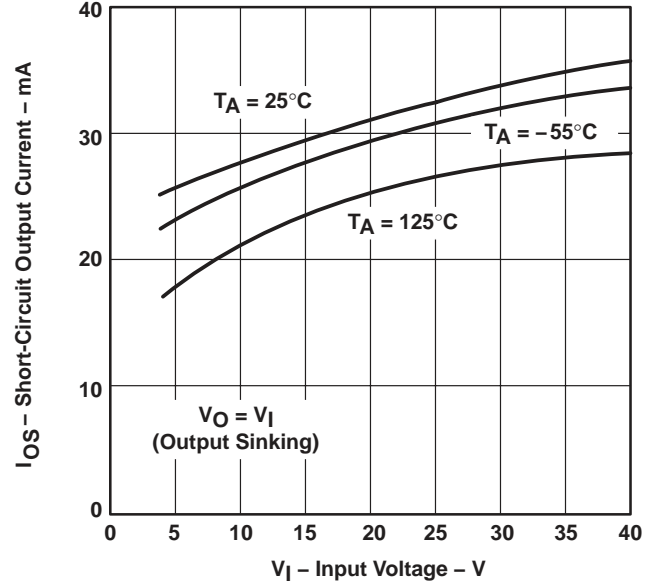


Figure 10

**SHORT-CIRCUIT OUTPUT CURRENT
 VS
 FREE-AIR TEMPERATURE**

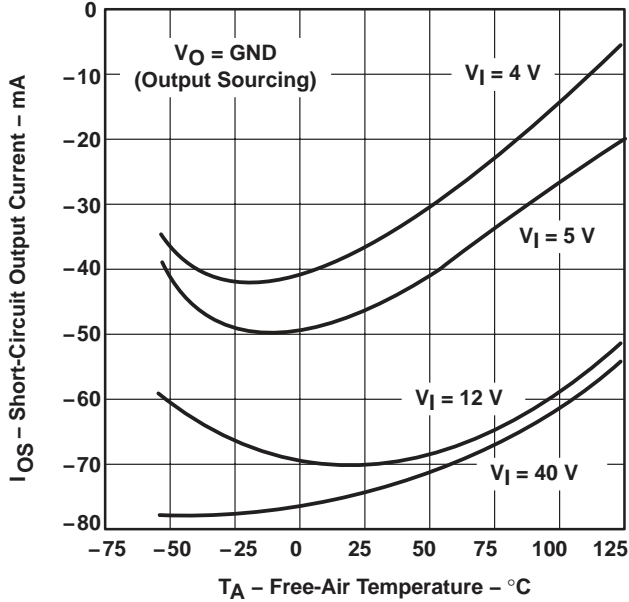


Figure 11

**SHORT-CIRCUIT OUTPUT CURRENT
 VS
 FREE-AIR TEMPERATURE**

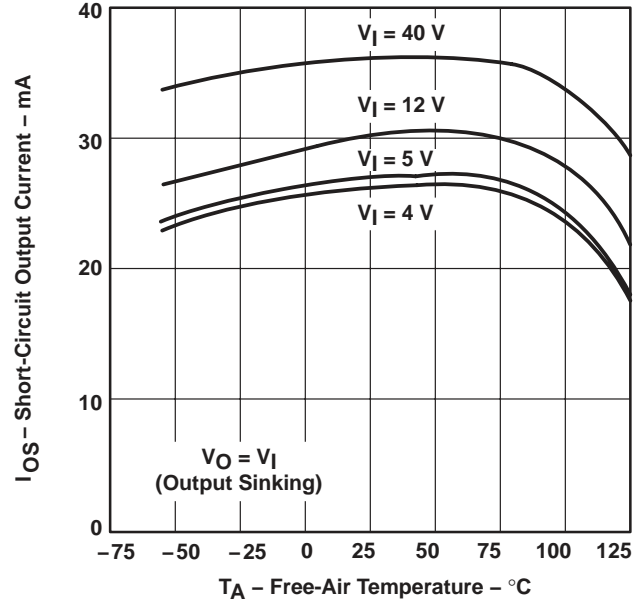


Figure 12

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

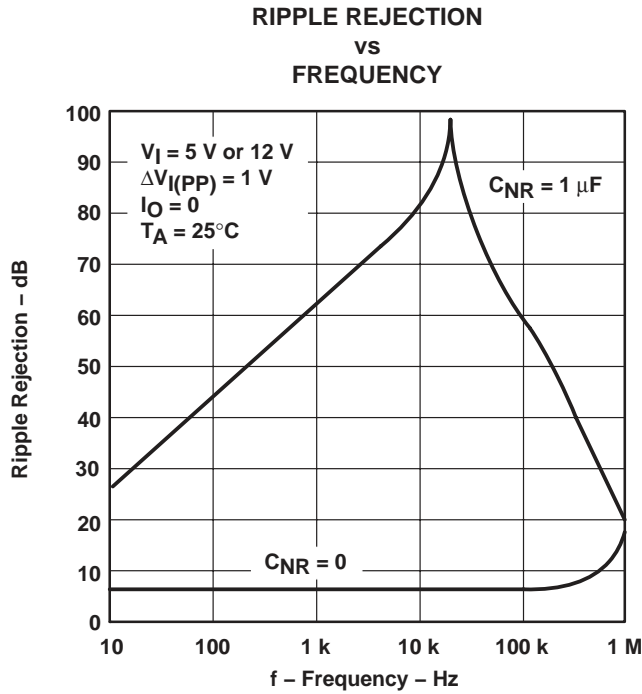


Figure 13

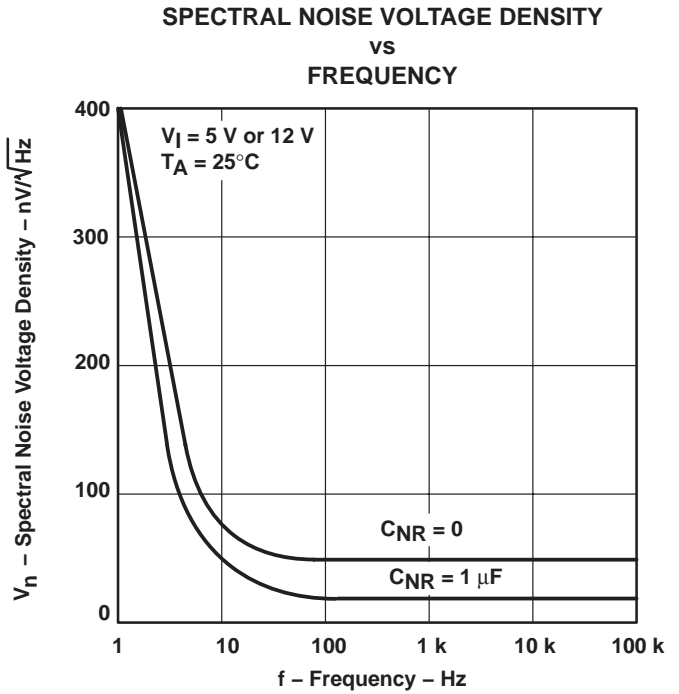


Figure 14

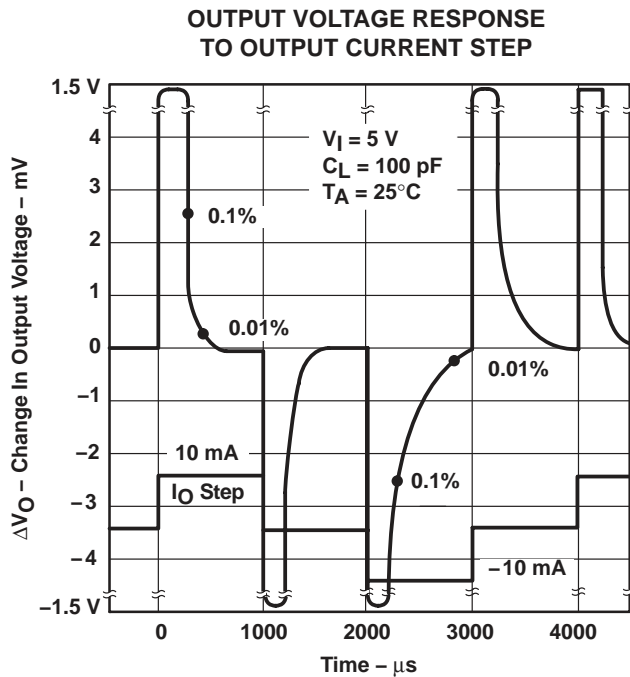


Figure 15

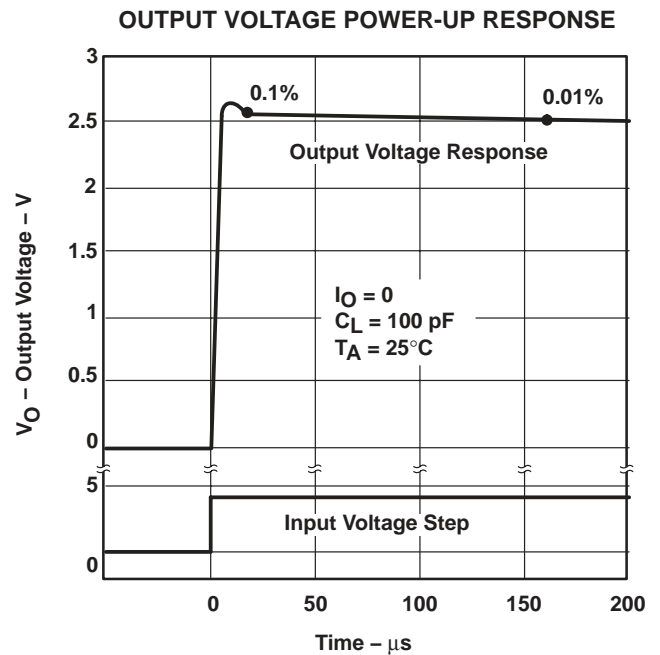


Figure 16

TYPICAL CHARACTERISTICS

**STABILITY RANGE
OUTPUT CURRENT
vs
LOAD CAPACITANCE**

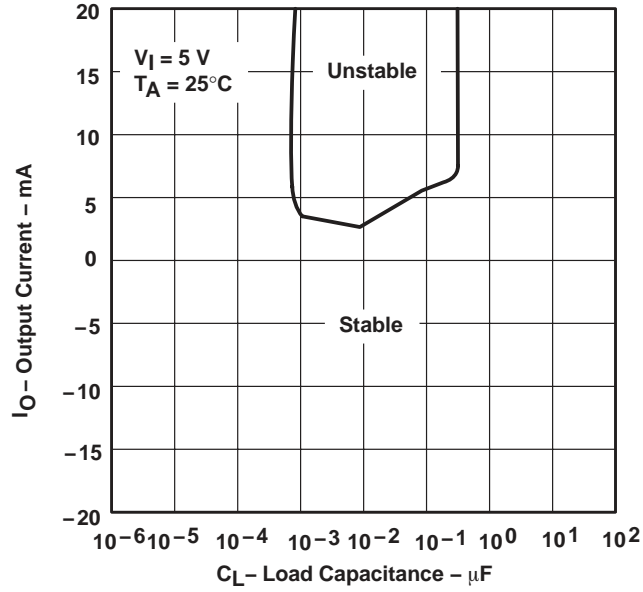
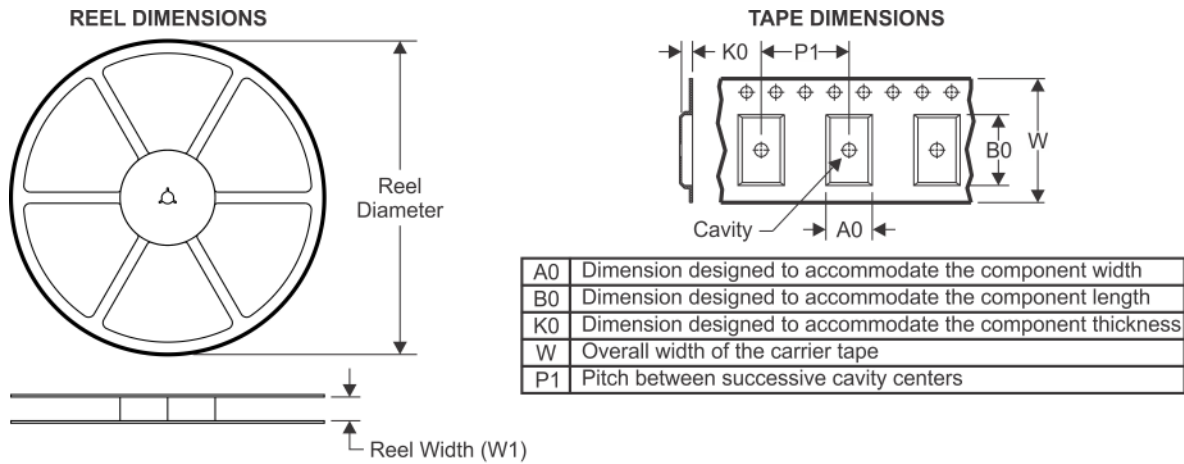
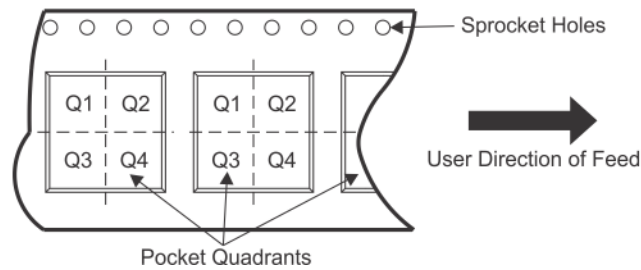


Figure 17

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLE2426MDREP | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLE2426MDREP | SOIC | D | 8 | 2500 | 350.0 | 350.0 | 43.0 |

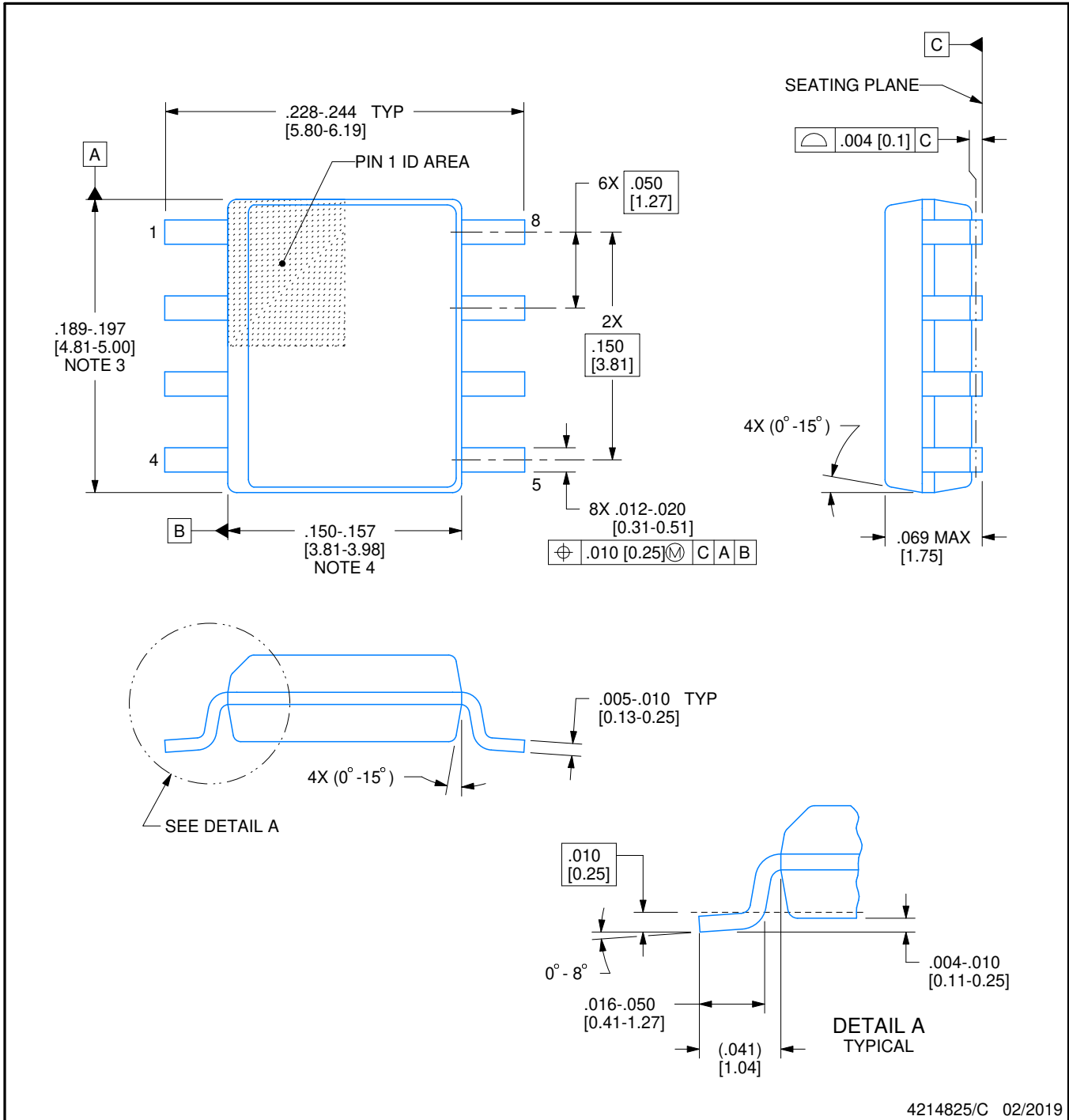


D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

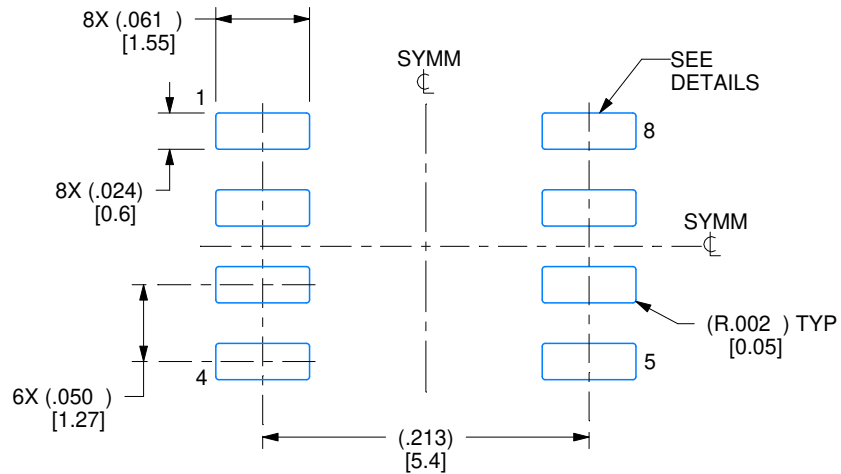
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

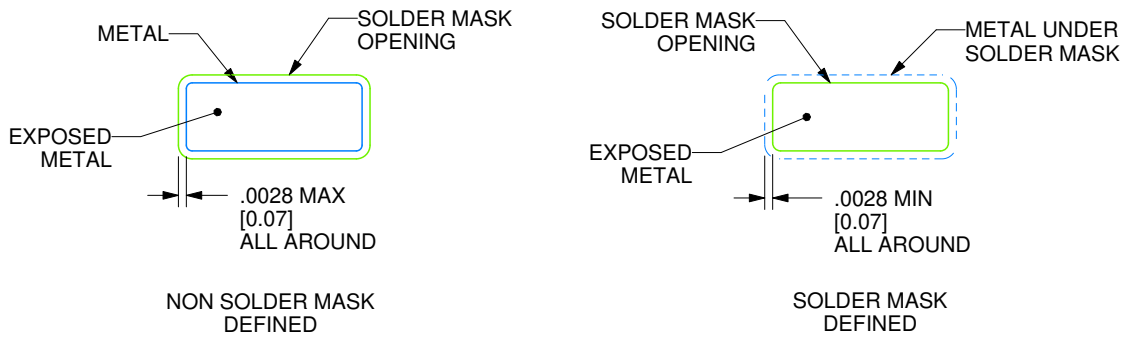
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

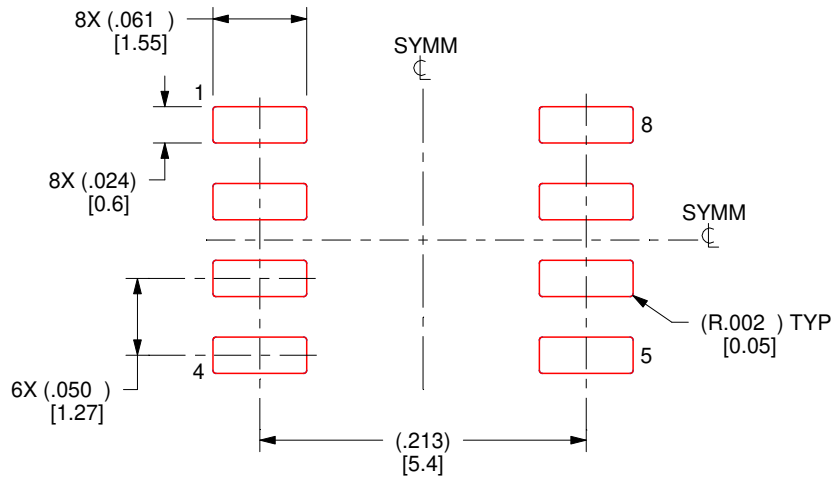
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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